



## Voltage Detectors , ME2808 Series

### General Description

**ME2808 Series** are a set of three-terminal low power voltage detectors implemented in NMOS technology. Each voltage detector in the series detects a particular fixed voltage ranging from 2.0V to 7.0V. The voltage detectors consist of a high precision and low power consumption standard voltage source, a comparator, hysteresis circuit, and an output driver. NMOS technology ensures low power consumption.

### Features

- Highly accuracy:  $\pm 1\%$
- Low power consumption: TYP 1.8uA ( $V_{in}=3V$ )
- Detect voltage range : 2.0V~7.0V in 0.1V increments
- Operating voltage range: 1.5V~18V
- Detect voltage temperature characteristics: TYP $\pm 0.9mV/^\circ C$
- Output configuration: NMOS
- Package: SOT-23-3, SOT-23-5, SOT-89-3, TO-92

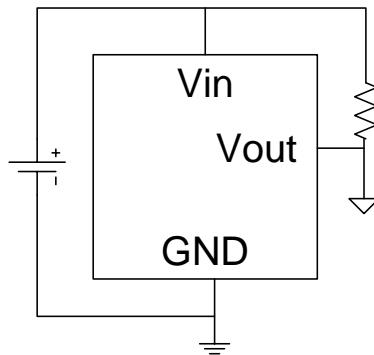
### Typical Application

- battery checkers
- Level selectors
- Power failure detectors
- Microcomputer reset
- Battery backup of Memories

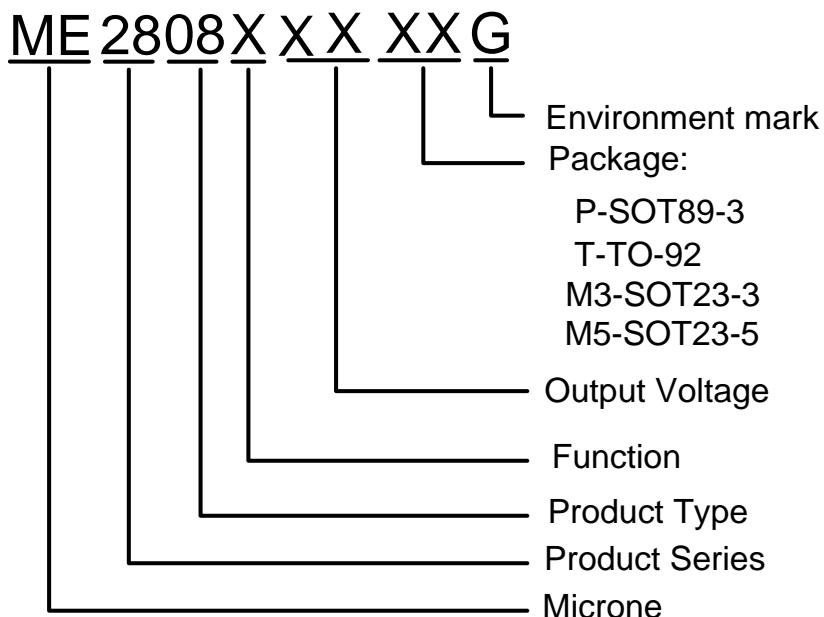
### Package

- 3-pin SOT23-3、SOT89-3、TO-92
- 5-pin SOT23-5

### Typical Application Circuit



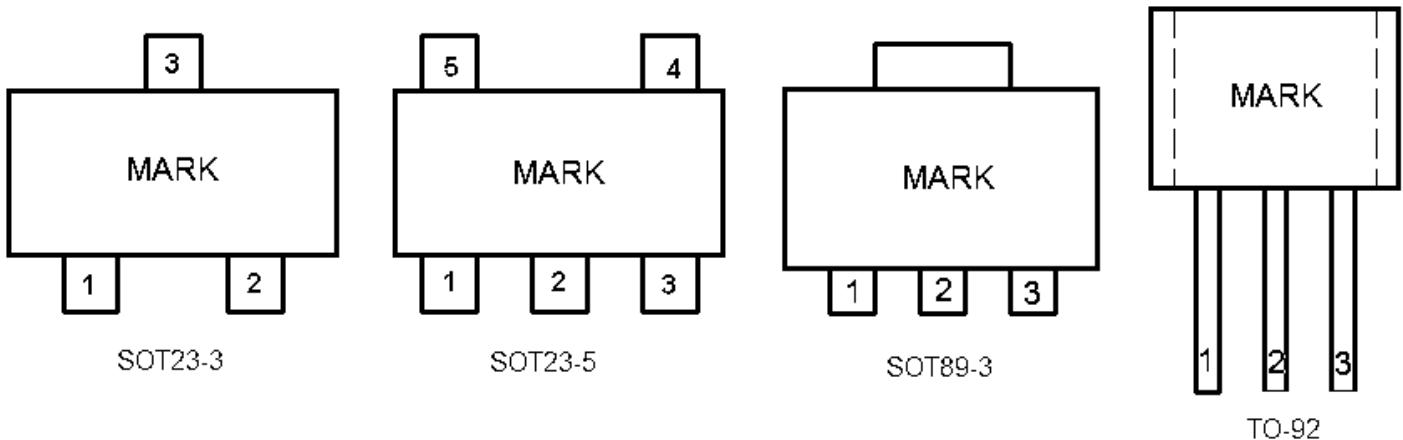
## Selection Guide



product series	product description
ME2808A22M3G	$V_{OUT} = 2.2V$ ; Rising edge detection; Package: SOT23-3
ME2808A33M3G	$V_{OUT} = 3.3V$ ; Rising edge detection; Package: SOT23-3
ME2808A30PG	$V_{OUT} = 3.0V$ ; Rising edge detection; Package: SOT89-3
ME2808A27TG	$V_{OUT} = 2.7V$ ; Rising edge detection; Package: TO-92
ME2808A42M5G	$V_{OUT} = 4.2V$ ; Rising edge detection; Package: SOT23-5
ME2808B28M3G	$V_{OUT} = 2.8V$ ; Falling edge detection; Package: SOT23-3

**NOTE:** At present ,there are seventeen kinds of voltage value: 2.2V、2.4V、2.5V、2.7V、2.8V、3.0V、3.2V、3.3V、3.5V、3.6V、3.8V、3.9V、4.0V、4.2V、4.3V、4.5V、5.0V。If you need other voltage and package, please contact our sales staff.

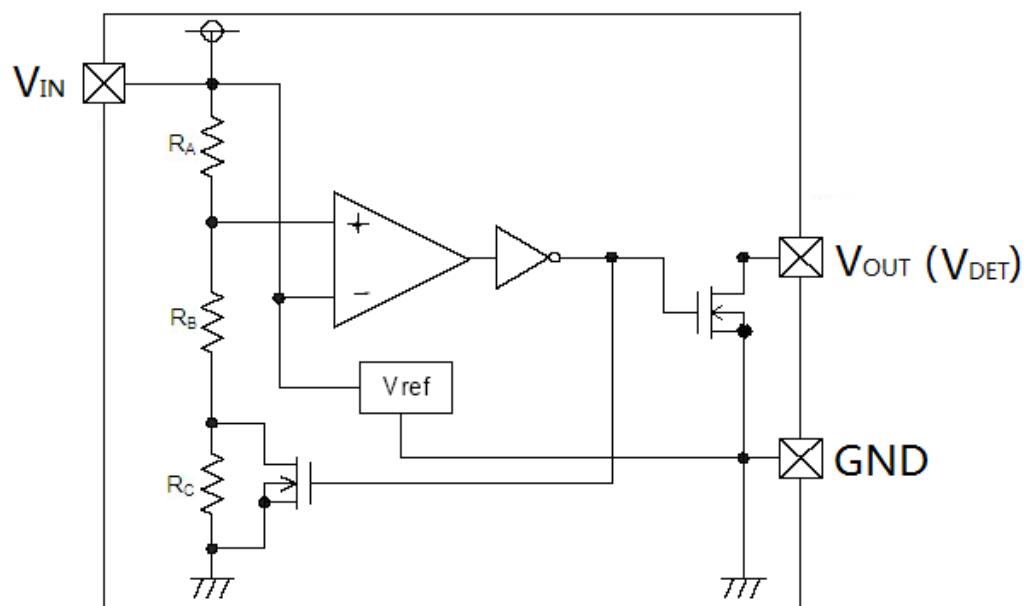
## Pin Configuration



## Pin Assignment

Pin Number				Pin Name	Functions
SOT-23-3	SOT-23-5	SOT-89-3	TO-92		
2	3	3	3	GND	Ground
1	1	1	1	V <sub>OUT</sub>	Output Voltage
3	2	2	2	V <sub>IN</sub>	Input Voltage
	4			NC	No Connection
	5			NC	No Connection

## Block Diagram



## Absolute Maximum Ratings

PARAMETER		SYMBAL	RATINGS	UNITS
V <sub>IN</sub> Input Voltage		V <sub>IN</sub>	18	V
Output Current		I <sub>OUT</sub>	50	mA
Output Voltage	NMOS	V <sub>OUT</sub>	GND-0.3~ V <sub>IN</sub> +0.3	V
Continuous Total Power Dissipation	SOT23-3/5	P <sub>D</sub>	300	mW
	SOT89-3		500	
	TO-92		500	
Operating Ambient Temperature		T <sub>Opr</sub>	-40~+85	°C
Storage Temperature		T <sub>stg</sub>	-50~+125	°C
Soldering temperature and time		T <sub>solder</sub>	260°C, 10s	

## Electrical Characteristics (V<sub>DET</sub> = 2.0V to 7.0V, T<sub>A</sub> = 25°C, unless otherwise noted)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Units
V <sub>DET</sub>	Detect Voltage			V <sub>DET</sub> ×0.99	V <sub>DET</sub>	V <sub>DET</sub> ×1.01	V
V <sub>HYS</sub>	Hysteresis Width			V <sub>DET</sub> ×0.02	V <sub>DET</sub> ×0.05	V <sub>DET</sub> ×0.1	V
I <sub>IN</sub>	Operating Current	V <sub>DET</sub> =2.0V~ 2.8V	V <sub>IN</sub> =3.0V	-	1.8	3	μA
		V <sub>DET</sub> =2.8V~ 3.6V	V <sub>IN</sub> =4.0V	-	1.8	4	
		V <sub>DET</sub> =3.6V ~ 4.7V	V <sub>IN</sub> =5.0V	-	2.1	4	
		V <sub>DET</sub> =4.7V~ 7.0V	V <sub>IN</sub> =8.0V	-	2.5	4	
V <sub>IN</sub>	Operating Voltage	V <sub>DET</sub> =2.0V to 7.0V		0.7	-	18	V
I <sub>OL</sub>	Output Sink Current	V <sub>DET</sub> =2.0V~ 2.8V	V <sub>IN</sub> =-V <sub>DET(S)</sub> -0.2V, V <sub>OUT</sub> =0.2V	0.5			mA
		V <sub>DET</sub> =2.8V~ 3.6V	V <sub>IN</sub> =-V <sub>DET(S)</sub> -0.5V, V <sub>OUT</sub> =0.3V	0.5			
		V <sub>DET</sub> =3.6V ~ 4.7V	V <sub>IN</sub> =-V <sub>DET(S)</sub> -0.5V, V <sub>OUT</sub> =0.3V	1.2			
		V <sub>DET</sub> =4.7V~ 7.0V	V <sub>IN</sub> =-V <sub>DET(S)</sub> -0.5V, V <sub>OUT</sub> =0.3V	2.5			
ΔV <sub>DET</sub> /ΔT <sub>A</sub>	Temperature characteristics	0°C≤T <sub>opr</sub> ≤70°C			±0.9		mV/°C

- Note:**
- 1、VDF(S) : Specified Detection Voltage value
  - 2、VDF : Actual Detection Voltage value
  - 3、Release Voltage: VDR=VDF+VHYS (ME2808A series)  
VDR=VDF-VHYS (ME2808B series)

## Functional Description

The ME2808 series is a set of voltage detectors equipped with a high stability voltage reference which is connected to the negative input of a comparator — denoted as  $V_{REF}$  in the following figure (Fig. 1). When the voltage drop to the positive input of the comparator (i.e.,  $V_B$ ) is higher than  $V_{REF}$ ,  $V_{OUT}$  goes high, M1 turns off, and  $V_B$  is expressed as  $V_{BH} = V_{IN} \times (R_B + R_C) / (R_A + R_B + R_C)$ . If  $V_{IN}$  is decreased so that  $V_B$  falls to a value that is less than  $V_{REF}$ , the comparator output inverts (from high to low),  $V_{OUT}$  goes low,  $V_C$  is high, M1 turns on,  $R_C$  is bypassed, and  $V_B$  becomes:  $V_{BL} = V_{IN} \times R_B / (R_A + R_B)$ , which is less than  $V_{BH}$ . By so doing the comparator out-put will stay low to prevent the circuit from oscillating when  $V_B \approx V_{REF}$ . If  $V_{IN}$  falls below the minimum operating voltage, the output becomes undefined. When  $V_{IN}$  goes from low to  $V_{IN} \times R_B / (R_A + R_B) > V_{REF}$ , the comparator output goes high and  $V_{OUT}$  goes high again. The detection voltage is as defined:

$$V_{DET(-)} = (R_A + R_B + R_C) \times V_{REF} / (R_B + R_C)$$

The release voltage is as defined:

$$V_{DET(+)} = (R_A + R_B) \times V_{REF} / R_B$$

The hysteresis width is:

$$V_{HYS} = V_{DET(+)} - V_{DET(-)}$$

Fig.1 demonstrates the NMOS output type with positive output polarity ( $V_{OUT}$  is normally high, active low).

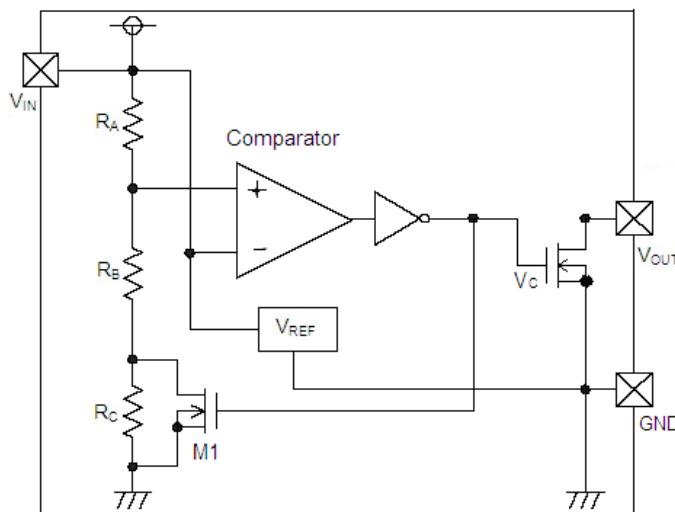
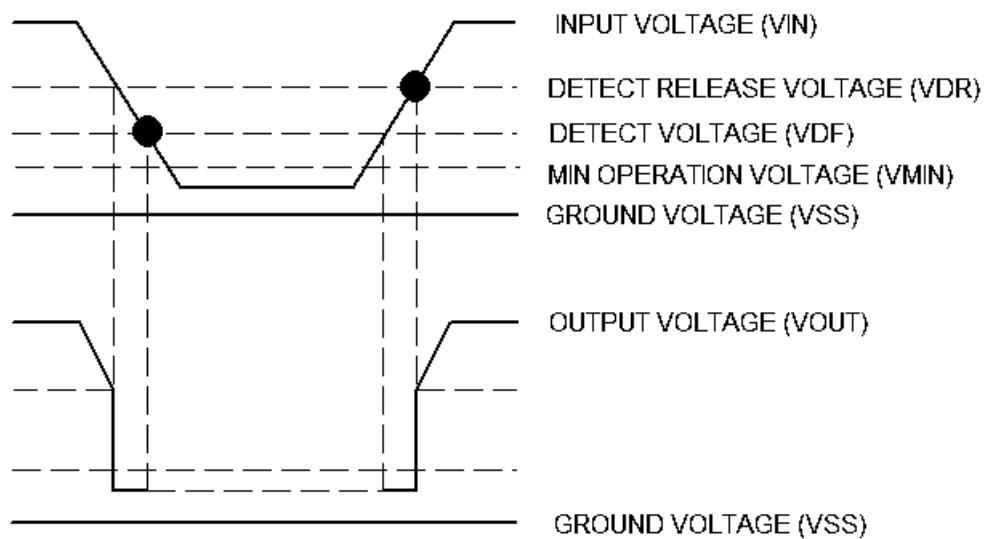


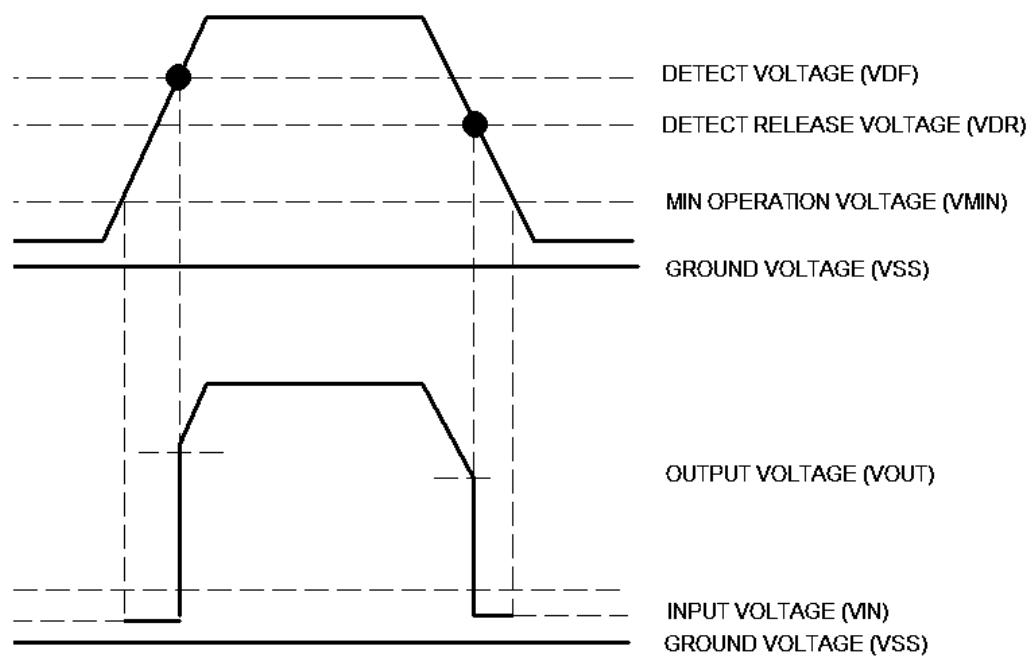
Fig.1 NMOS output voltage detector (ME2808)

## Timing Chart

**ME2808A:**

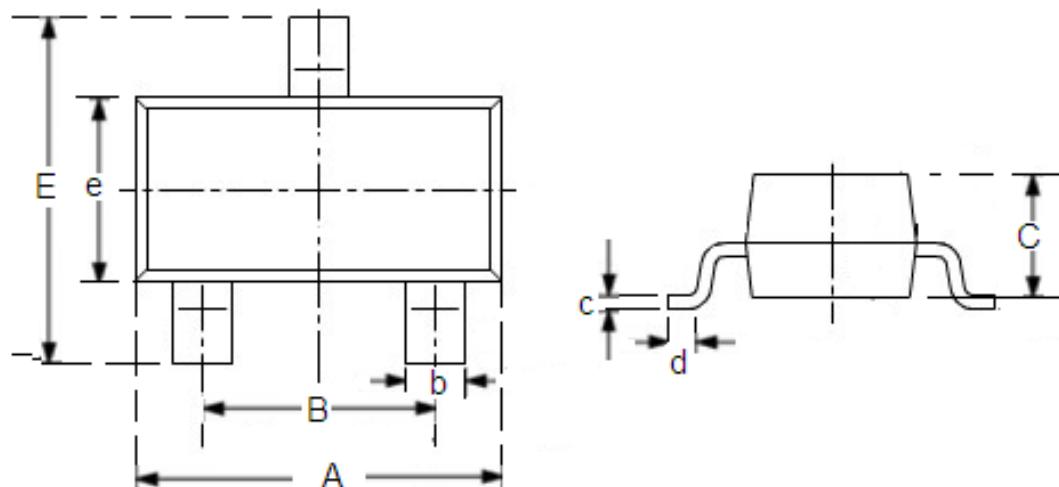


**ME2808B:**



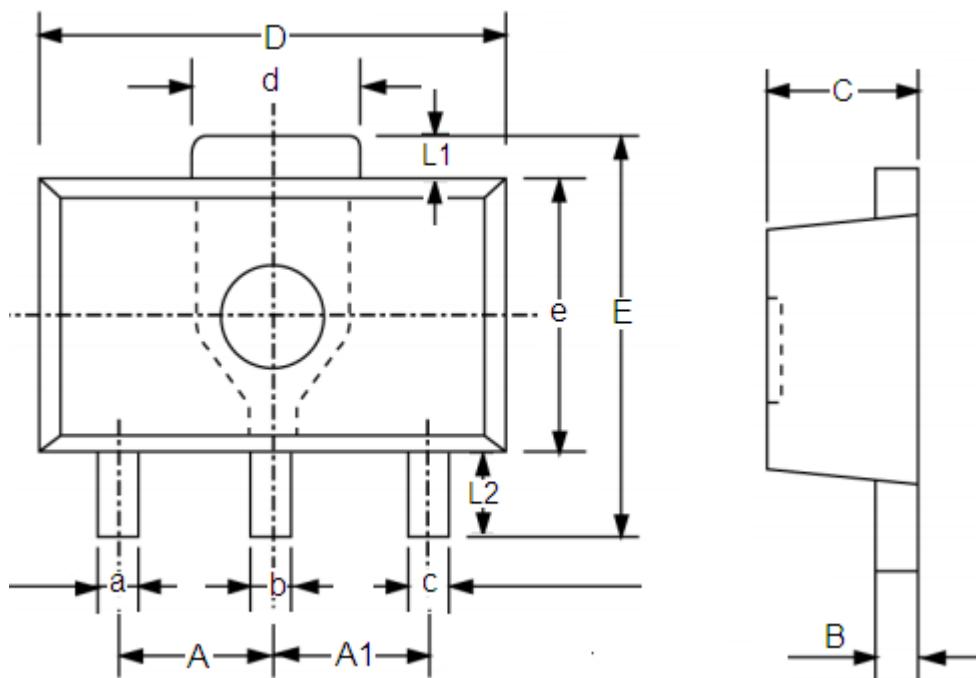
## Packaging Information

### ● SOT23-3



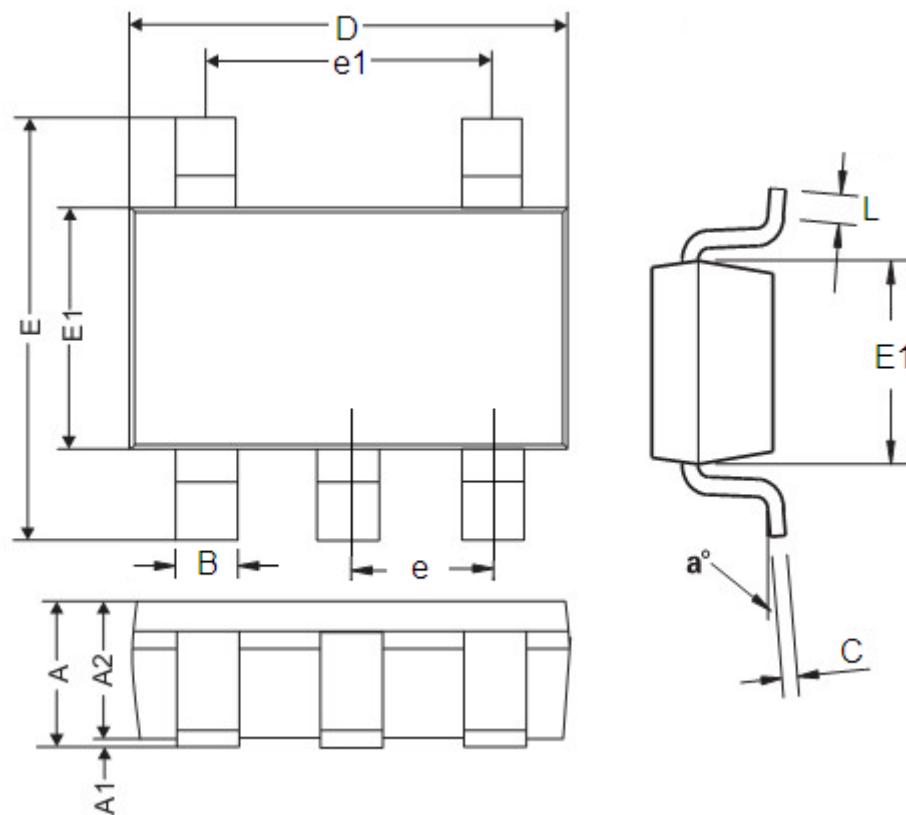
DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	2.7	3.1	0.1063	0.122
B	1.7	2.1	0.0669	0.0827
b	0.35	0.5	0.0138	0.0197
C	1.0	1.2	0.0394	0.0472
c	0.1	0.25	0.0039	0.0098
d	0.2	-	0.0079	-
E	2.6	3.0	0.1023	0.1181
e	1.5	1.8	0.059	0.0708

## ● SOT89-3



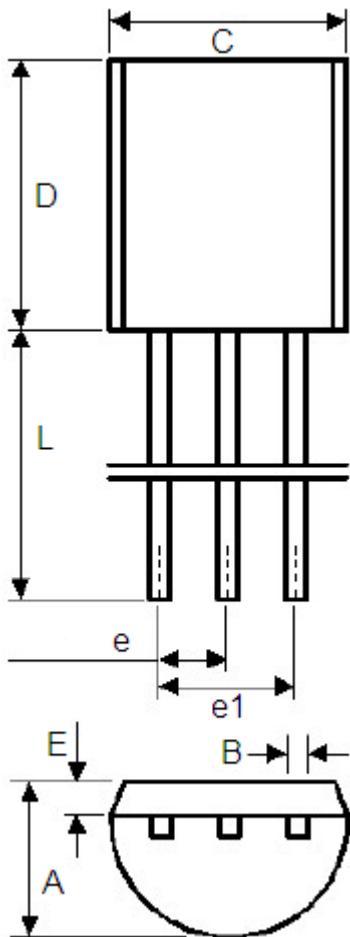
DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	1.4	1.6	0.0551	0.0630
A1	1.4	1.6	0.0551	0.0630
a	0.36	0.48	0.0142	0.0189
b	0.41	0.53	0.0161	0.0209
c	0.36	0.48	0.0142	0.0189
d	1.4	1.75	0.0551	0.0689
B	0.38	0.43	0.015	0.0169
C	1.4	1.6	0.0551	0.0630
D	4.4	4.6	0.1732	0.181
E	-	4.25	-	0.1673
e	2.4	2.6	0.0945	0.1023
L1	0.4	-	0.0157	-
L2	0.8	-	0.0315	-

## ● SOT23-5



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	0.9	1.45	0.0354	0.0570
A1	0	0.15	0	0.0059
A2	0.9	1.3	0.0354	0.0511
B	0.2	0.5	0.0078	0.0196
C	0.09	0.26	0.0035	0.0102
D	2.7	3.10	0.1062	0.1220
E	2.2	3.2	0.0866	0.1181
E1	1.30	1.80	0.0511	0.0708
e	0.95REF		0.0374REF	
e1	1.90REF		0.0748REF	
L	0.10	0.60	0.0039	0.0236
a°	0°	30°	0°	30°

● TO-92



DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	3.4	3.8	0.13386	0.1496
B	0.3	0.5	0.0118	0.0197
C	4.4	4.8	0.1732	0.189
D	4.4	4.8	0.1732	0.189
E	0.9	1.5	0.0354	0.059
e	1.17	1.37	0.046	0.0539
e1	2.39	2.69	0.094	0.1059
L	12	16	0.4724	0.6299

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